4-bit dual supply translating transceiver with configurable voltage translation; 3-state

Rev. 4 — 14 December 2011

**Product data sheet** 

### 1. General description

The 74AVCH4T245 is a 4-bit, dual supply transceiver that enables bidirectional level translation. The device can be used as two 2-bit transceivers or as a 4-bit transceiver. It features two 2-bit input-output ports (nAn and nBn), a direction control input (nDIR), a output enable input (nOE) and dual supply pins ( $V_{CC(A)}$  and  $V_{CC(B)}$ ). Both  $V_{CC(A)}$  and  $V_{CC(B)}$  can be supplied at any voltage between 0.8 V and 3.6 V making the device suitable for translating between any of the low voltage nodes (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V). Pins nAn, nOE and nDIR are referenced to  $V_{CC(A)}$  and pins nBn are referenced to  $V_{CC(B)}$ . A HIGH on nDIR allows transmission from nAn to nBn and a LOW on nDIR allows transmission from nBn to nAn. The output enable input (nOE) can be used to disable the outputs so the buses are effectively isolated.

The device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both nAn and nBn outputs are in the high-impedance OFF-state. The bus hold circuitry on the powered-up side always stays active.

The 74AVCH4T245 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

### 2. Features and benefits

- Wide supply voltage range:
  - ◆ V<sub>CC(A)</sub>: 0.8 V to 3.6 V
  - V<sub>CC(B)</sub>: 0.8 V to 3.6 V
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114E Class 3B exceeds 8000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Maximum data rates:
  - ◆ 380 Mbit/s (≥ 1.8 V to 3.3 V translation)



4-bit dual supply translating transceiver; 3-state

- ◆ 200 Mbit/s (≥ 1.1 V to 3.3 V translation)
- ◆ 200 Mbit/s (≥ 1.1 V to 2.5 V translation)
- 200 Mbit/s ( $\geq$  1.1 V to 1.8 V translation)
- ◆ 150 Mbit/s (≥ 1.1 V to 1.5 V translation)
- ◆ 100 Mbit/s (≥ 1.1 V to 1.2 V translation)
- Suspend mode
- Bus hold on data inputs
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

### 3. Ordering information

#### Table 1.Ordering information

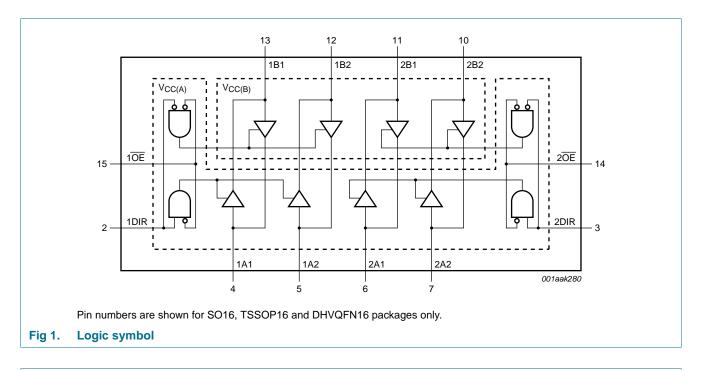
Type number	Package							
	Temperature range	Name	Description	Version				
74AVCH4T245D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1				
74AVCH4T245PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1				
74AVCH4T245BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1				
74AVCH4T245GU	–40 °C to +125 °C	XQFN16	plastic, extremely thin quad flat package; no leads; 16 terminals; body $1.80 \times 2.60 \times 0.50$ mm	SOT1161-1				

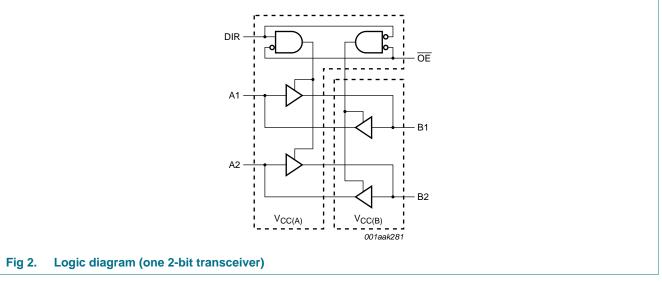
### 4. Marking

Table 2.   Marking codes		
Type number	Marking code	
74AVCH4T245D	74AVCH4T245D	
74AVCH4T245PW	CH4T245	
74AVCH4T245BQ	H4T245	
74AVCH4T245GU	К4	

4-bit dual supply translating transceiver; 3-state

## 5. Functional diagram

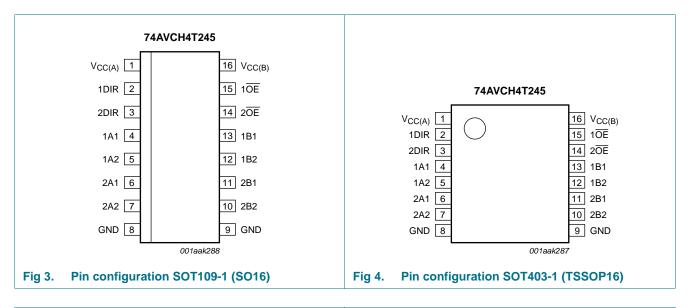


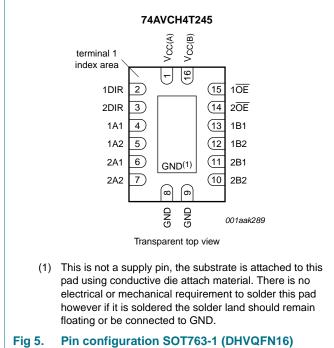


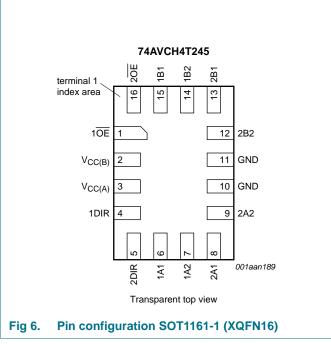
4-bit dual supply translating transceiver; 3-state

## 6. Pinning information

### 6.1 Pinning







74AVCH4T245 Product data sheet

4-bit dual supply translating transceiver; 3-state

Symbol	Pin		Description		
	SOT109-1, SOT403-1 and SOT763-1	SOT1161-1			
V <sub>CC(A)</sub>	1	3	supply voltage A (nAn, n $\overline{\text{OE}}$ and nDIR inputs are referenced to $V_{\text{CC}(A)})$		
1DIR, 2DIR	2, 3	4, 5	direction control		
1A1, 1A2	4, 5	6, 7	data input or output		
2A1, 2A2	6, 7	8, 9	data input or output		
GND <sup>[1]</sup>	8, 9	10, 11	ground (0 V)		
2B2, 2B1	10, 11	12, 13	data input or output		
1B2, 1B1	12, 13	14, 15	data input or output		
2 <u>0E</u> , 1 <u>0E</u>	14, 15	16, 1	output enable input (active LOW)		
V <sub>CC(B)</sub>	16	2	supply voltage B (nBn inputs are referenced to $V_{CC(B)}$ )		

### 6.2 Pin description

[1] All GND pins must be connected to ground (0 V).

## 7. Functional description

#### Table 4.Function table

Supply voltage	Input	nput In		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	nOE <sup>[2]</sup>	nDIR <sup>[2]</sup>	nAn <sup>[2]</sup>	nBn <sup>[2]</sup>
0.8 V to 3.6 V	L	L	nAn = nBn	input
0.8 V to 3.6 V	L	Н	input	nBn = nAn
0.8 V to 3.6 V	Н	Х	Z	Z
GND <sup>[3]</sup>	Х	Х	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The nAn, nDIR and nOE input circuit is referenced to V<sub>CC(A)</sub>; The nBn input circuit is referenced to V<sub>CC(B)</sub>.

[3] If at least one of  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into suspend mode.

5 of 29

4-bit dual supply translating transceiver; 3-state

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
Ι <sub>ΟΚ</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	Active mode	[ <u>1][2][3]</u> _0.5	V <sub>CCO</sub> + 0.5	5 V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CCO}$	[2] _	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>	-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
		SO16, TSSOP16 and DHVQFN16	<u>[4]</u> _	500	mW
		XQFN16	[5] _	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

[3]  $V_{CCO}$  + 0.5 V should not exceed 4.6 V.

[4] For SO16 package: above 70 °C the value of P<sub>tot</sub> derates linearly at 8 mW/K.

For TSSOP16 package: above 60 °C the value of  $P_{tot}$  derates linearly at 5.5 mW/K. For DHVQFN16 package: above 60 °C the value of  $P_{tot}$  derates linearly at 4.5 mW/K.

[5] For XQFN16 package: above 133 °C the value of  $P_{tot}$  derates linearly with 14.5 mW/K.

## 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		0.8	3.6	V
V <sub>CC(B)</sub>	supply voltage B		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	[1] 0	V <sub>CCO</sub>	V
		Suspend or 3-state mode	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CCI} = 0.8 \text{ V} \text{ to } 3.6 \text{ V}$	[2] _	5	ns/V

[1] V<sub>CCO</sub> is the supply voltage associated with the output port.

[2]  $V_{CCI}$  is the supply voltage associated with the input port.

4-bit dual supply translating transceiver; 3-state

### **10. Static characteristics**

#### Table 7. Typical static characteristics at $T_{amb} = 25 \text{ °C}$

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.07	-	V
l <sub>l</sub>	input leakage current	nDIR, n $\overline{OE}$ input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.025	±0.25	μΑ
I <sub>BHL</sub>	bus hold LOW current	A or B port; $V_I$ = 0.42 V; $V_{CC(A)}$ = $V_{CC(B)}$ = 1.2 V	<u>[3]</u>	26	-	μΑ
I <sub>BHH</sub>	bus hold HIGH current	A or B port; $V_I = 0.78$ V; $V_{CC(A)} = V_{CC(B)} = 1.2$ V	<u>[4]</u> _	-24	-	μΑ
I <sub>BHLO</sub>	bus hold LOW overdrive current	A or B port; $V_{CC(A)} = V_{CC(B)} = 1.2 V$	<u>[5]</u> _	27	-	μΑ
I <sub>BHHO</sub>	bus hold HIGH overdrive current	A or B port; $V_{CC(A)} = V_{CC(B)} = 1.2 V$	<u>[6]</u> _	-26	-	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 3.6 V$	[7] -	±0.5	±2.5	μA
		suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}$ ; $V_{CC(A)} = 3.6 V$ ; $V_{CC(B)} = 0 V$	[7] -	±0.5	±2.5	μA
		suspend mode B port; $V_0 = 0 V \text{ or } V_{CCO}$ ; $V_{CC(A)} = 0 V$ ; $V_{CC(B)} = 3.6 V$	<u>[7]</u> _	±0.5	±2.5	μΑ
I <sub>OFF</sub>	power-off leakage current	A port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μA
		B port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μΑ
CI	input capacitance	nDIR, n $\overline{OE}$ input; V <sub>I</sub> = 0 V or 3.3 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 3.3 V	-	1.0	-	pF
C <sub>I/O</sub>	input/output capacitance	A and B port; $V_O = 3.3 \text{ V or } 0 \text{ V}$ ; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	4.0	-	pF

[1] V<sub>CCO</sub> is the supply voltage associated with the output port.

[2] V<sub>CCI</sub> is the supply voltage associated with the data input port.

[3] The bus hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>I</sub> to GND and then raising it to V<sub>IL</sub> max.

[4] The bus hold circuit can source at least the minimum high sustaining current at  $V_{IH}$  min.  $I_{BHH}$  should be measured after raising  $V_I$  to  $V_{CC}$  and then lowering it to  $V_{IH}$  min.

[5] An external driver must source at least I<sub>BHLO</sub> to switch this node from LOW to HIGH.

[6] An external driver must sink at least  $I_{BHHO}$  to switch this node from HIGH to LOW.

[7] For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

# 74AVCH4T245

Unit

### 4-bit dual supply translating transceiver; 3-state

#### Table 8. Static characteristics [1][2]

At recomi	mended operat	ing conditions; voltages are referenced to	GND (grour	d = 0 V).		
Symbol	Parameter	Conditions	–40 °C to	o +85 °C	–40 °C to	+125 °C
			Min	Max	Min	Max

-,							
			Min	Max	Min	Max	
/ <sub>IH</sub>	HIGH-level	data input					
	input voltage	$V_{CCI} = 0.8 V$	0.70V <sub>CCI</sub>	-	0.70V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	0.65V <sub>CCI</sub>	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2	-	2	-	V
		nDIR, nOE input					
		$V_{CC(A)} = 0.8 V$	0.70V <sub>CC(A)</sub>	-	0.70V <sub>CC(A)</sub>	-	V
		$V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$	2	-	2	-	V
	LOW-level	data input					
	input voltage	V <sub>CCI</sub> = 0.8 V	-	0.30V <sub>CCI</sub>	-	0.30V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CCI</sub>	-	0.35V <sub>CCI</sub>	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.8	-	0.8	V
		nDIR, nOE input					
		$V_{CC(A)} = 0.8 V$	-	0.30V <sub>CC(A)</sub>	-	0.30V <sub>CC(A)</sub>	V
		$V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$	-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.8	-	0.8	V
ОН	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V$	V <sub>CCO</sub> – 0.1	-	$V_{CCO}-0.1$	-	V
		$I_O = -3 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	0.85	-	0.85	-	V
		$I_O = -6 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	1.05	-	1.05	-	V
		$I_O = -8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	1.2	-	1.2	-	V
		$I_O = -9 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	1.75	-	1.75	-	V
		$I_{O} = -12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	2.3	-	2.3	-	V

# 74AVCH4T245

#### 4-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	–40 °C	to +85 °C	-40 °C to	+125 °C	Uni
			Min	Max	Min	Max	
OL	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$				I	
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V$	-	0.1	-	0.1	V
		$I_{O} = 3 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		I <sub>O</sub> = 8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	-	0.45	-	0.45	V
		$I_{O} = 9 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	-	0.55	-	0.55	V
		$I_{O} = 12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	-	0.7	-	0.7	V
	input leakage current	nDIR, n $\overline{OE}$ input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±1	-	±5	μA
BHL	bus hold	A or B port	[3]				
	LOW current	V <sub>I</sub> = 0.49 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.4 V	15	-	15	-	μA
		V <sub>I</sub> = 0.58 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	25	-	25	-	μΑ
		V <sub>I</sub> = 0.70 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 2.3 V	45	-	45	-	μΑ
		$V_{I} = 0.80 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	100	-	90	-	μA
ЗНН	bus hold	A or B port	[4]				
	HIGH current	$V_{I} = 0.91 V;$ $V_{CC(A)} = V_{CC(B)} = 1.4 V$	-15	-	–15	-	μA
		$V_{I} = 1.07 V;$ $V_{CC(A)} = V_{CC(B)} = 1.65 V$	-25	-	-25	-	μΑ
		$V_{I} = 1.60 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	-100	-	-100	-	μΑ
BHLO	bus hold	A or B port	<u>[5]</u>				
	LOW overdrive	$V_{CC(A)} = V_{CC(B)} = 1.6 V$	125	-	125	-	μΑ
	current	$V_{CC(A)} = V_{CC(B)} = 1.95 V$	200	-	200	-	μA
		$V_{CC(A)} = V_{CC(B)} = 2.7 \text{ V}$	300	-	300	-	μA
		$V_{CC(A)} = V_{CC(B)} = 3.6 \text{ V}$	500	-	500	-	μA
HHO	bus hold	A or B port	[6]				
	HIGH overdrive	$V_{CC(A)} = V_{CC(B)} = 1.6 V$	-125	-	-125	-	μA
	current	$V_{CC(A)} = V_{CC(B)} = 1.95 V$	-200	-	-200	-	μΑ
		$V_{CC(A)} = V_{CC(B)} = 2.7 \text{ V}$	-300	-	-300	-	μΑ
		$V_{CC(A)} = V_{CC(B)} = 3.6 V$	-500	-	-500	-	μA

#### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Product data sheet

74AVCH4T245

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# 74AVCH4T245

#### 4-bit dual supply translating transceiver; 3-state

#### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

		0 / 0		10	,			
Symbol	Parameter	rameter Conditions		–40 °C to +85 °C		–40 °C to	+125 °C	Unit
				Min	Max	Min	Max	
I <sub>OZ</sub>	OFF-state output	A or B port; $V_O = 0 V \text{ or } V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 3.6 V$	[7]	-	±5	-	±30	μA
	current	suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 3.6 V;$ $V_{CC(B)} = 0 V$	<u>[7]</u>	-	±5	-	±30	μΑ
		suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 3.6 V$	<u>[7]</u>	-	±5	-	±30	μA
leaka	power-off leakage current	A port; V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	±5	-	±30	μΑ
		B port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V		-	±5	-	±30	μΑ

## 74AVCH4T245

#### 4-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	–40 °C t	o +85 °C	-40 °C to	o +125 ℃	Unit
			Min	Max	Min	Max	
I <sub>CC</sub>	supply	A port; $V_I = 0$ V or $V_{CCI}$ ; $I_O = 0$ A		'	1		
	current	$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	10	-	55	μΑ
	$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ - 8 $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	8	-	50	μA		
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-	8	-	50	μΑ
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-2	-	-12	-	μΑ
		B port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$					
		$V_{CC(A)} = 0.8 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	-	10	-	55	μA
		$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	8	-	50	μΑ
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-2	-	-12	-	μΑ
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-	8	-	50	μA
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_0 = 0$ A; $V_1 = 0$ V or $V_{CC1}$ ; $V_{CC(A)} = 0.8$ V to 3.6 V; $V_{CC(B)} = 0.8$ V to 3.6 V	-	20	-	70	μΑ
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_0 = 0$ A; $V_1 = 0$ V or $V_{CC1}$ ; $V_{CC(A)} = 1.1$ V to 3.6 V; $V_{CC(B)} = 1.1$ V to 3.6 V	-	16	-	65	μΑ

#### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2]  $V_{CCI}$  is the supply voltage associated with the data input port.

- [3] The bus hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>I</sub> to GND and then raising it to V<sub>IL</sub> max.
- [4] The bus hold circuit can source at least the minimum high sustaining current at  $V_{IH}$  min.  $I_{BHH}$  should be measured after raising  $V_I$  to  $V_{CC}$  and then lowering it to  $V_{IH}$  min.
- [5] An external driver must source at least  $I_{BHLO}$  to switch this node from LOW to HIGH.
- [6] An external driver must sink at least I<sub>BHHO</sub> to switch this node from HIGH to LOW.
- [7] For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

#### Table 9. Typical total supply current (I<sub>CC(A)</sub> + I<sub>CC(B)</sub>)

V <sub>CC(A)</sub>	V <sub>CC(B)</sub>		V <sub>CC(B)</sub>										
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V						
0 V	0	0.1	0.1	0.1	0.1	0.1	0.1	μA					
0.8 V	0.1	0.1	0.1	0.1	0.1	0.3	1.6	μA					
1.2 V	0.1	0.1	0.1	0.1	0.1	0.1	0.8	μA					
1.5 V	0.1	0.1	0.1	0.1	0.1	0.1	0.4	μA					
1.8 V	0.1	0.1	0.1	0.1	0.1	0.1	0.2	μA					
2.5 V	0.1	0.3	0.1	0.1	0.1	0.1	0.1	μΑ					
3.3 V	0.1	1.6	0.8	0.4	0.2	0.1	0.1	μΑ					

74AVCH4T245

**Product data sheet** 

4-bit dual supply translating transceiver; 3-state

### **11. Dynamic characteristics**

#### Table 10. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C } [1][2]$

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions			V <sub>CC(A)</sub> =	= V <sub>CC(B)</sub>			Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
$C_{PD}$	C <sub>PD</sub> power dissipation capacitance	A port: (direction nAn to nBn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	рF
		A port: (direction nAn to nBn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	рF
	A port: (direction nBn to nAn); output enabled	9.5	9.7	9.8	9.9	10.7	11.9	pF	
		A port: (direction nBn to nAn); output disabled	0.6	0.6	0.6	0.6	0.7	0.7	pF
		B port: (direction nAn to nBn); output enabled	9.5	9.7	9.8	9.9	10.7	11.9	pF
		B port: (direction nAn to nBn); output disabled	0.6	0.6	0.6	0.6	0.7	0.7	pF
	B port: (direction nBn to nAn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	pF	
		B port: (direction nBn to nAn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

[2]  $f_i = 10 \text{ MHz}$ ;  $V_I = \text{GND}$  to  $V_{CC}$ ;  $t_r = t_f = 1 \text{ ns}$ ;  $C_L = 0 \text{ pF}$ ;  $R_L = \infty \Omega$ .

### 4-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>							
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V		
t <sub>pd</sub>	propagation delay	nAn to nBn	14.5	7.3	6.5	6.2	5.9	6.0	ns	
		nBn to nAn	14.5	12.7	12.4	12.3	12.1	12.0	ns	
t <sub>dis</sub>	disable time	nOE to nAn	14.3	14.3	14.3	14.3	14.3	14.3	ns	
		nOE to nBn	17.0	9.9	9.0	9.4	9.0	9.7	ns	
t <sub>en</sub>	t <sub>en</sub> enable time	nOE to nAn	18.2	18.2	18.2	18.2	18.2	18.2	ns	
	nOE to nBn	19.2	10.7	9.8	9.6	9.7	10.2	ns		

# Table 11. Typical dynamic characteristics at $V_{CC(A)} = 0.8 V$ and $T_{amb} = 25 \ ^{\circ}C$ [1]Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### Table 12. Typical dynamic characteristics at $V_{CC(B)} = 0.8$ V and $T_{amb} = 25$ °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8

Symbol	Parameter	Conditions	V <sub>CC(A)</sub>						
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	t <sub>pd</sub> propagation delay	nAn to nBn	14.5	12.7	12.4	12.3	12.1	12.0	ns
		nBn to nAn	14.5	7.3	6.5	6.2	5.9	6.0	ns
t <sub>dis</sub>	disable time	nOE to nAn	14.3	5.5	4.1	4.0	3.0	3.5	ns
		nOE to nBn	17.0	13.8	13.4	13.1	12.9	12.7	ns
t <sub>en</sub>	t <sub>en</sub> enable time	nOE to nAn	18.2	5.6	4.0	3.2	2.4	2.2	ns
		nOE to nBn	19.2	14.6	14.1	13.9	13.7	13.6	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

### 4-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>									Unit	
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V		0.15 V	2.5 V :	± 0.2 V	3.3 V	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	-
$V_{CC(A)} =$	1.1 V to 1.3 V												
t <sub>pd</sub> propagation	nAn to nBn	0.5	9.4	0.5	7.1	0.5	6.2	0.5	5.2	0.5	5.1	ns	
	delay	nBn to nAn	0.5	9.4	0.5	8.9	0.5	8.7	0.5	8.4	0.5	8.2	ns
t <sub>dis</sub>	disable time	n <mark>OE</mark> to nAn	1.8	10.9	1.8	10.9	1.8	10.9	1.8	10.9	1.8	10.9	ns
		nOE to nBn	1.9	12.4	1.9	9.6	1.9	9.5	1.4	8.1	1.2	9.1	ns
t <sub>en</sub>	enable time	nOE to nAn	1.4	12.8	1.4	12.8	1.4	12.8	1.4	12.8	1.4	12.8	ns
		nOE to nBn	1.1	13.3	1.1	10.0	1.1	8.9	1.0	7.9	1.0	7.7	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.3	8.9	0.3	6.3	0.3	5.2	0.3	4.2	0.3	4.2	ns
	delay	nBn to nAn	0.7	7.1	0.7	6.3	0.5	6.0	0.4	5.7	0.3	5.6	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.8	10.2	1.8	10.2	1.5	10.2	1.3	10.2	1.6	10.2	ns
		nOE to nBn	1.9	11.3	1.9	10.3	1.9	9.1	1.4	7.4	1.2	7.6	ns
t <sub>en</sub>	enable time	nOE to nAn	1.1	9.4	1.4	9.4	1.1	9.4	0.7	9.4	0.4	9.4	ns
		nOE to nBn	1.4	12.1	1.4	9.6	1.1	7.7	0.9	5.8	0.9	5.6	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t <sub>pd</sub> propagation	nAn to nBn	0.1	8.7	0.1	6.0	0.1	4.9	0.1	3.9	0.3	3.9	ns	
-	delay	nBn to nAn	0.6	6.2	0.6	5.3	0.5	4.9	0.3	4.6	0.3	4.5	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.8	8.6	1.6	8.6	1.8	8.6	1.3	8.6	1.6	8.6	ns
		nOE to nBn	1.7	10.9	1.7	9.9	1.6	8.7	1.2	6.9	1.0	6.9	ns
t <sub>en</sub>	enable time	nOE to nAn	1.0	7.2	1.0	7.2	1.0	7.2	0.6	7.2	0.4	7.2	ns
		nOE to nBn	1.2	11.7	1.2	9.2	1.0	7.4	0.8	5.3	0.8	4.6	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.1	8.4	0.1	5.7	0.1	4.6	0.2	3.5	0.1	3.6	ns
	delay	nBn to nAn	0.6	5.2	0.6	4.2	0.4	3.9	0.2	3.4	0.2	3.3	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.0	6.2	1.0	6.2	1.0	6.2	1.0	6.2	1.0	6.2	ns
		nOE to nBn	1.5	10.4	1.5	8.8	1.3	8.2	1.1	6.2	0.9	5.2	ns
t <sub>en</sub>	enable time	nOE to nAn	0.7	4.8	0.7	4.8	0.7	4.8	0.6	4.8	0.4	4.8	ns
		nOE to nBn	0.9	11.3	0.9	8.8	0.8	7.0	0.6	4.8	0.6	4.0	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.1	8.2	0.1	5.6	0.1	4.5	0.1	3.3	0.1	2.9	ns
	delay	nBn to nAn	0.6	5.1	0.6	4.2	0.4	3.4	0.2	3.0	0.1	2.8	ns
t <sub>dis</sub>	disable time	nOE to nAn	0.7	5.6	0.7	5.6	0.7	5.6	0.7	5.6	0.7	5.6	ns
		nOE to nBn	1.4	10.2	1.4	9.3	1.2	8.1	1.0	6.4	0.8	6.2	ns
t <sub>en</sub>	enable time	nOE to nAn	0.6	3.8	0.6	3.8	0.6	3.8	0.6	3.8	0.4	3.8	ns
-611		nOE to nBn	0.8	11.3	0.8	8.7	0.6	6.8	0.5	4.7	0.5	3.8	ns

## **Table 13.** Dynamic characteristics for temperature range -40 °C to +85 °C 11

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### 4-bit dual supply translating transceiver; 3-state

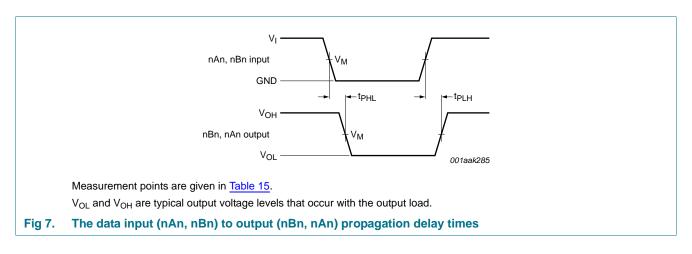
Symbol	Parameter	Conditions			V <sub>CC(B)</sub>					Uni			
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V	1	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
$V_{CC(A)} =$	1.1 V to 1.3 V												
t <sub>pd</sub> propagation	nAn to nBn	0.5	10.4	0.5	7.9	0.5	6.9	0.5	5.8	0.5	5.7	ns	
-	delay	nBn to nAn	0.5	10.4	0.5	9.8	0.5	9.6	0.5	9.3	0.5	9.1	ns
disable time	nOE to nAn	1.8	12.0	1.8	12.0	1.8	12.0	1.8	12.0	1.8	12.0	ns	
		nOE to nBn	1.9	13.7	1.9	10.6	1.9	10.5	1.4	9.0	1.2	10.1	ns
t <sub>en</sub>	enable time	nOE to nAn	1.4	14.1	1.4	14.1	1.4	14.1	1.4	14.1	1.4	14.1	ns
		nOE to nBn	1.1	14.7	1.1	11.0	1.1	9.8	1.0	8.7	1.0	8.5	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.3	9.8	0.3	7.0	0.3	5.8	0.3	4.7	0.3	4.7	ns
	delay	nBn to nAn	0.7	7.9	0.7	7.0	0.5	6.6	0.4	6.3	0.3	6.2	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.8	11.3	1.8	11.3	1.5	11.3	1.3	11.3	1.6	11.3	ns
		nOE to nBn	1.9	12.5	1.9	11.4	1.9	10.1	1.4	8.2	1.2	8.4	ns
t <sub>en</sub>	enable time	nOE to nAn	1.1	10.4	1.4	10.4	1.1	10.4	0.7	10.4	0.4	10.4	ns
		nOE to nBn	1.4	13.3	1.4	10.6	1.1	8.5	0.9	6.4	0.9	6.2	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t <sub>pd</sub> propagation delay	propagation	nAn to nBn	0.1	9.6	0.1	6.6	0.1	5.4	0.1	4.3	0.3	4.3	ns
	delay	nBn to nAn	0.6	6.9	0.6	5.9	0.5	5.4	0.3	5.1	0.3	5.0	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.8	9.5	1.6	9.5	1.8	9.5	1.3	9.5	1.6	9.5	ns
		nOE to nBn	1.7	12.0	1.7	10.9	1.6	9.6	1.2	7.6	1.0	7.6	ns
t <sub>en</sub>	enable time	nOE to nAn	1.0	8.0	1.0	8.0	1.0	8.0	0.6	8.0	0.4	8.0	ns
		nOE to nBn	1.2	12.9	1.2	10.2	1.0	8.2	0.8	5.9	0.8	5.1	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.1	9.3	0.1	6.3	0.1	5.1	0.2	4.0	0.1	4.0	ns
	delay	nBn to nAn	0.6	5.8	0.6	4.7	0.4	4.3	0.2	3.9	0.2	3.8	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.0	6.9	1.0	6.9	1.0	6.9	1.0	6.9	1.0	6.9	ns
		nOE to nBn	1.5	11.5	1.5	10.4	1.3	9.1	1.1	6.9	0.9	5.8	ns
t <sub>en</sub>	enable time	nOE to nAn	0.7	5.3	0.7	5.3	0.7	5.3	0.6	5.3	0.4	5.3	ns
		nOE to nBn	0.9	12.4	0.9	9.7	0.8	7.7	0.6	5.3	0.6	4.4	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.1	9.1	0.1	6.2	0.1	5.0	0.1	3.8	0.1	3.3	ns
-	delay	nBn to nAn	0.6	5.7	0.6	4.7	0.4	3.9	0.2	3.4	0.1	3.3	ns
t <sub>dis</sub>	disable time	nOE to nAn	0.7	6.2	0.7	6.2	0.7	6.2	0.7	6.2	0.7	6.2	ns
-		nOE to nBn	1.4	11.3	1.4	10.3	1.2	9.0	1.0	7.1	0.8	6.9	ns
t <sub>en</sub>	enable time	nOE to nAn	0.6	4.2	0.6	4.2	0.6	4.2	0.6	4.2	0.4	4.2	ns
		nOE to nBn	0.8	12.4	0.8	9.6	0.6	7.5	0.5	5.2	0.5	4.2	ns

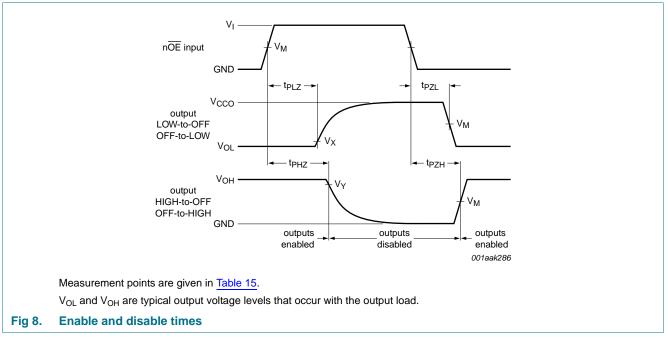
## Table 14. Dynamic characteristics for temperature range -40 °C to +125 °C [1]

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

4-bit dual supply translating transceiver; 3-state

## 12. Waveforms





#### Table 15.Measurement points

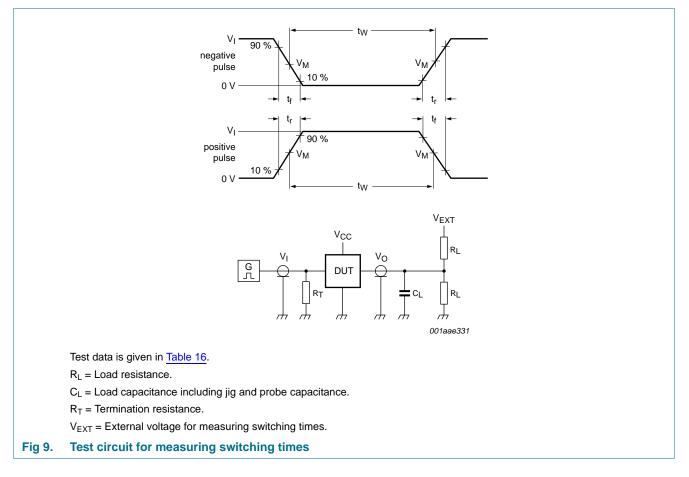
Supply voltage	Input <sup>[1]</sup>	Output <sup>[2]</sup>		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
0.8 V to 1.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> – 0.1 V
1.65 V to 2.7 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
3.0 V to 3.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

# 74AVCH4T245

#### 4-bit dual supply translating transceiver; 3-state



#### Table 16. Test data

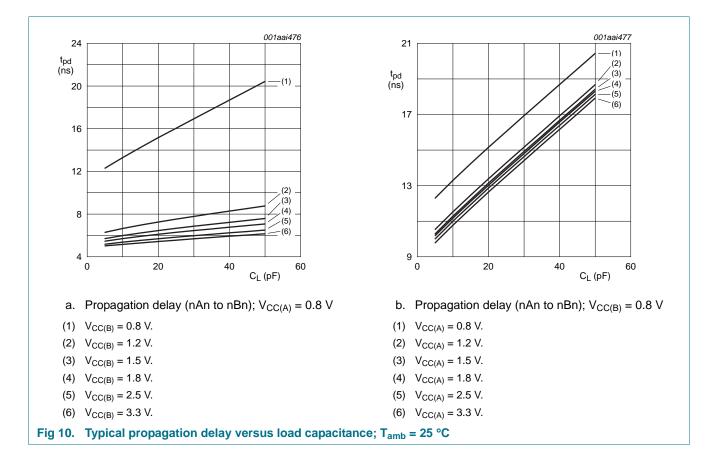
Supply voltage	Input		Load	Load		V <sub>EXT</sub>			
$V_{CC(A)}, V_{CC(B)}$	V <sub>I</sub> [1]	∆t/∆V[2]	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]		
0.8 V to 1.6 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>		
1.65 V to 2.7 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>		
3.0 V to 3.6 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>		

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

 $[2] \quad dV/dt \geq 1.0 \ V/ns$ 

[3]  $V_{CCO}$  is the supply voltage associated with the output port.

#### 4-bit dual supply translating transceiver; 3-state

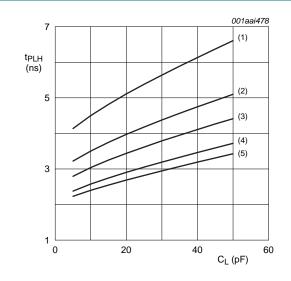


## 13. Typical propagation delay characteristics

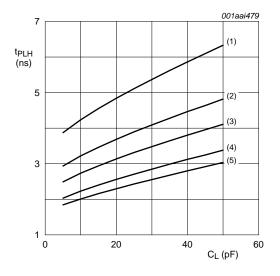
74AVCH4T245 Product data sheet

# 74AVCH4T245

#### 4-bit dual supply translating transceiver; 3-state

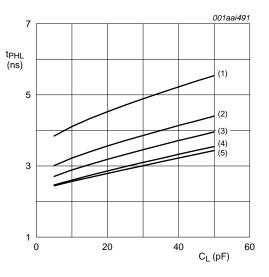


a. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)} = 1.2 \text{ V}$ 

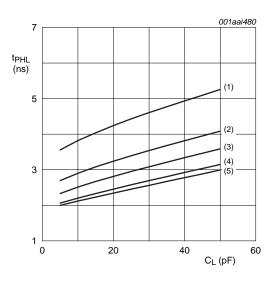


- c. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)} = 1.5 \text{ V}$
- (1)  $V_{CC(B)} = 1.2$  V.
- (2) V<sub>CC(B)</sub> = 1.5 V.
- (3) V<sub>CC(B)</sub> = 1.8 V.
- (4) V<sub>CC(B)</sub> = 2.5 V.
- (5)  $V_{CC(B)} = 3.3$  V.

Fig 11. Typical propagation delay versus load capacitance;  $T_{amb} = 25 \text{ °C}$ 



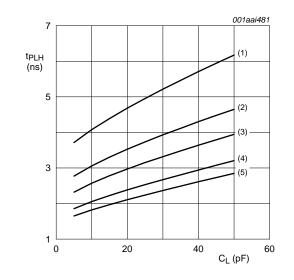
b. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)} = 1.2 \text{ V}$ 



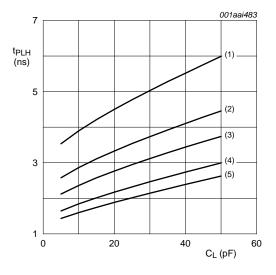
d. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)} = 1.5 \text{ V}$ 

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#### 4-bit dual supply translating transceiver; 3-state

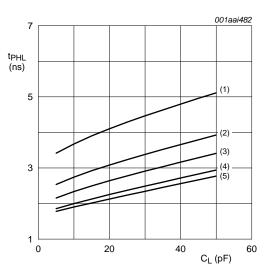


a. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)} = 1.8 \text{ V}$ 

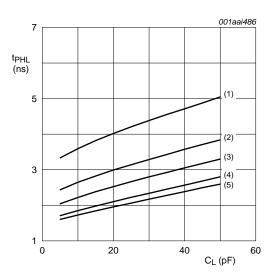


- c. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)}$  = 2.5 V
- (1)  $V_{CC(B)} = 1.2$  V.
- (2) V<sub>CC(B)</sub> = 1.5 V.
- (3) V<sub>CC(B)</sub> = 1.8 V.
- (4)  $V_{CC(B)} = 2.5$  V.
- (5)  $V_{CC(B)} = 3.3$  V.

Fig 12. Typical propagation delay versus load capacitance;  $T_{amb} = 25 \text{ °C}$ 



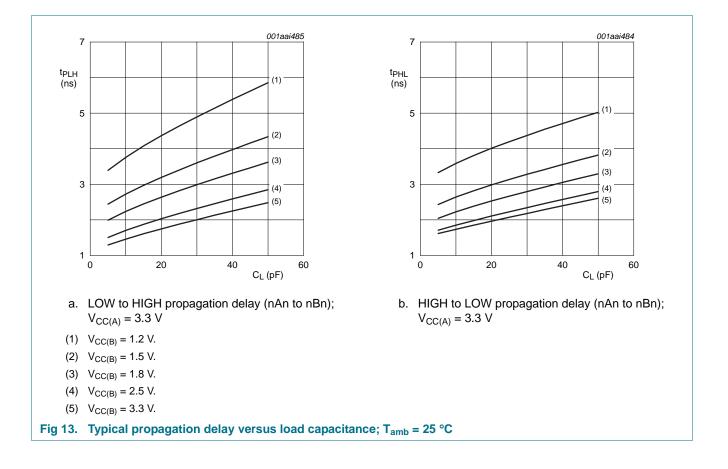
b. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)} = 1.8 \text{ V}$ 



d. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)} = 2.5 \text{ V}$ 

# 74AVCH4T245

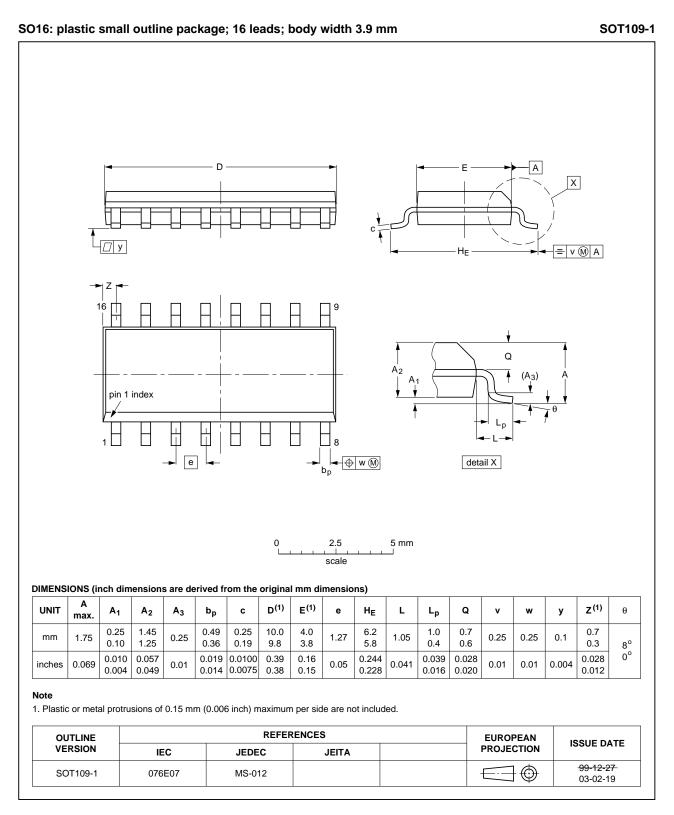
#### 4-bit dual supply translating transceiver; 3-state



## 74AVCH4T245

4-bit dual supply translating transceiver; 3-state

### 14. Package outline



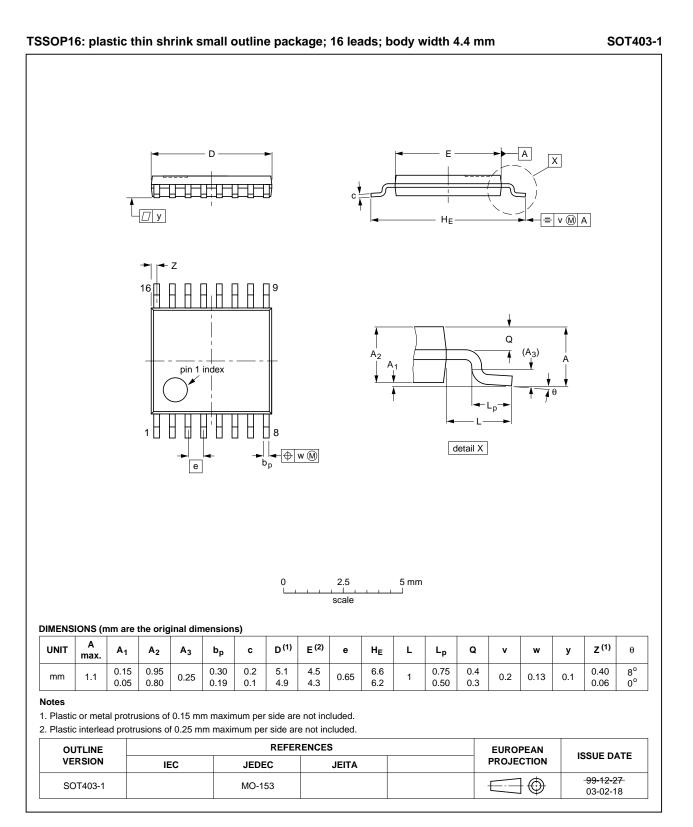
#### Fig 14. Package outline SOT109-1 (SO16)

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74AVCH4T245

#### 22 of 29

4-bit dual supply translating transceiver; 3-state

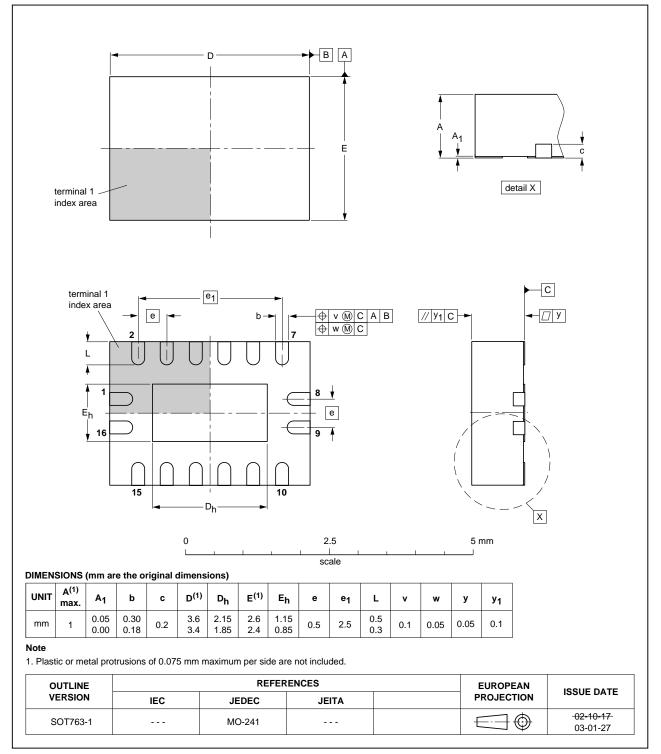


#### Fig 15. Package outline SOT403-1 (TSSOP16)

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74AVCH4T245

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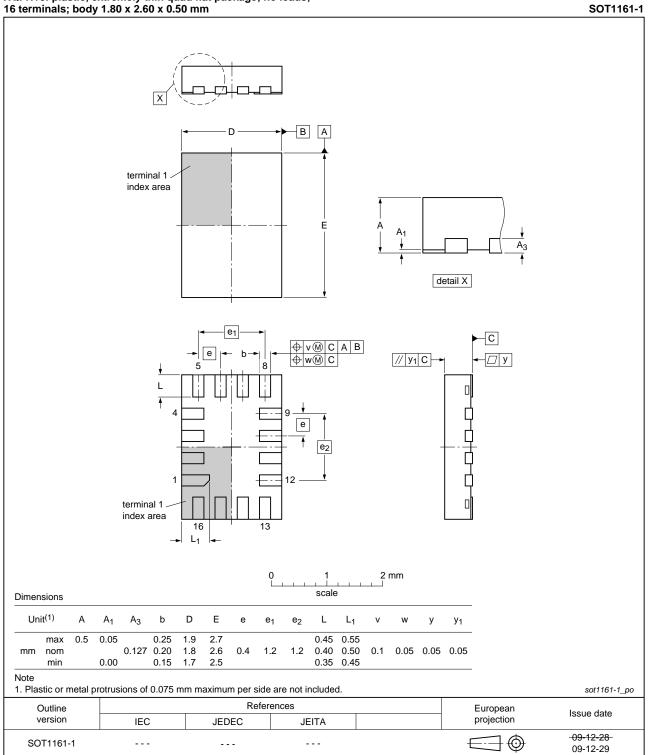
DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

#### Fig 16. Package outline SOT763-1 (DHVQFN16)

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74AVCH4T245

4-bit dual supply translating transceiver; 3-state



XQFN16: plastic, extremely thin quad flat package; no leads; 16 terminals; body 1.80 x 2.60 x 0.50 mm

#### Fig 17. Package outline SOT1161-1 (XQFN16)

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74AVCH4T245

4-bit dual supply translating transceiver; 3-state

## **15. Abbreviations**

Table 17. Abbr	eviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

## **16. Revision history**

#### Table 18. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVCH4T245 v.4	20111214	Product data sheet	-	74AVCH4T245 v.3
Modifications:	<ul> <li>Legal pages</li> </ul>	updated.		
74AVCH4T245 v.3	20110927	Product data sheet	-	74AVCH4T245 v.2
74AVCH4T245 v.2	20101203	Product data sheet	-	74AVCH4T245 v.1
74AVCH4T245 v.1	20090806	Product data sheet	-	-

4-bit dual supply translating transceiver; 3-state

## 17. Legal information

### 17.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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### **19. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 3
6	Pinning information 4
6.1	Pinning 4
6.2	Pin description 5
7	Functional description 5
8	Limiting values 6
9	Recommended operating conditions 6
10	Static characteristics 7
11	Dynamic characteristics 12
12	Waveforms 16
13	Typical propagation delay characteristics 18
14	Package outline 22
15	Abbreviations
16	Revision history 26
17	Legal information 27
17.1	Data sheet status 27
17.2	Definitions 27
17.3	Disclaimers
17.4	Trademarks
18	Contact information 28
19	Contents 29

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